



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



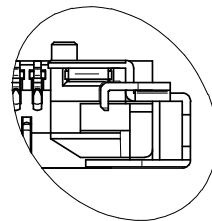
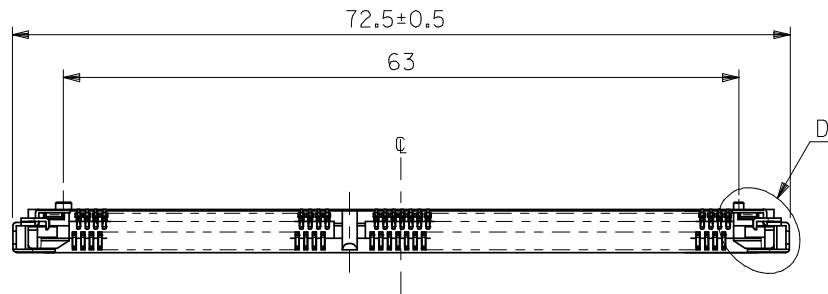
## Contact us

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詳細 D  
DETAIL D  
(SCALE:5-1)

注記 1. 材料 ハウジング : ガラス入り耐熱樹脂、白色、UL94V-0  
MATERIAL HOUSING : G.F.HEAT RESISTANT PLASTIC,WHITE,UL94V-0  
ターミナル : 磷青銅  
TERMINAL : PHOSPHOR BRONZE  
ネイル : 黄銅  
NAIL : BRASS

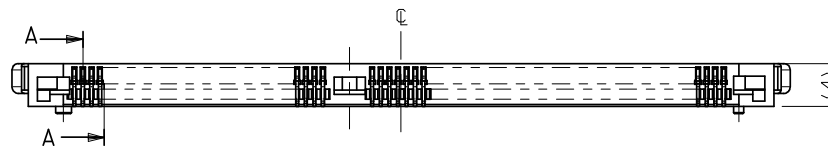
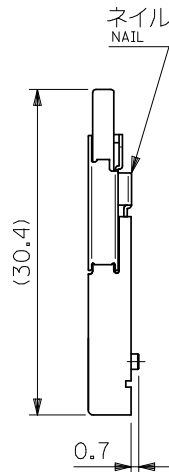
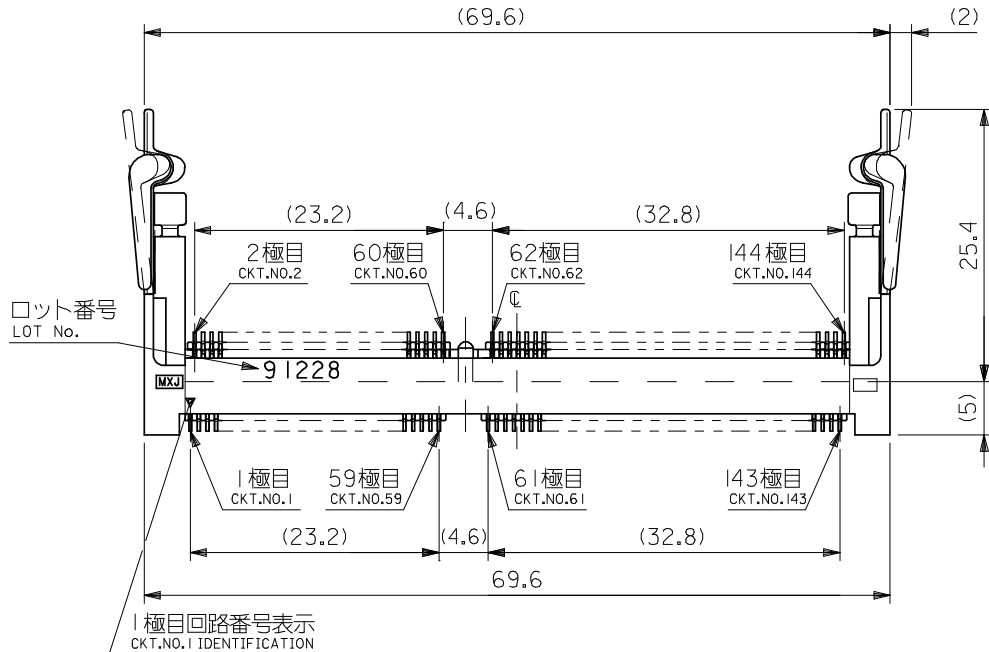
2. めっき仕様  
PLATING

ロングターミナル  
LONG TERMINAL  
接点部 : 金めっき 0.25μmMIN.  
CONTACT AREA : GOLD 0.25 μmMIN.  
半田付け部 : 半田めっき 1.0μmMIN.  
SOLDER TAIL AREA : TIN-LEAD 1.0μmMIN.  
下地めっき : ニッケルめっき 2.0μmMIN.  
UNDER-PLATING : NICKEL 2.0μmMIN.

ショートターミナル  
SHORT TERMINAL  
接点部 : 金めっき 0.25μmMIN.  
CONTACT AREA : GOLD 0.25 μmMIN.  
半田付け部 : 金めっき 0.3μmMAX.  
SOLDER TAIL AREA : GOLD 0.3μmMAX.  
下地めっき : ニッケルめっき 2.0μmMIN.  
UNDER-PLATING : NICKEL 2.0μmMIN.

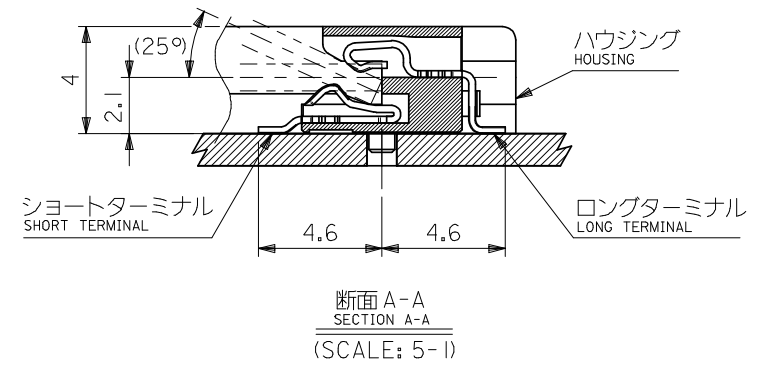
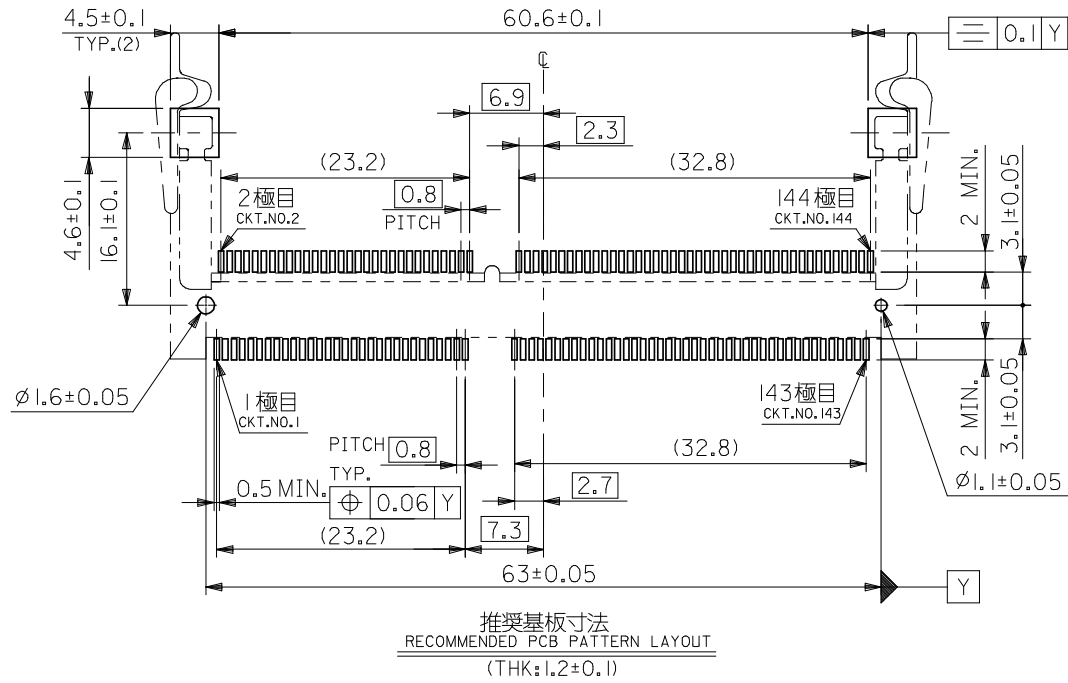
ネイル  
NAIL  
半田めっき : 2.0μmMIN.  
TIN-LEAD : 2.0μmMIN.

3. テール平坦度は、0.1 MAX.とする。  
TAIL COPLANARITY TO BE 0.1 MAX.  
ネイル平坦度は、0.1 MAX.とする。  
NAIL COPLANARITY TO BE 0.1 MAX.

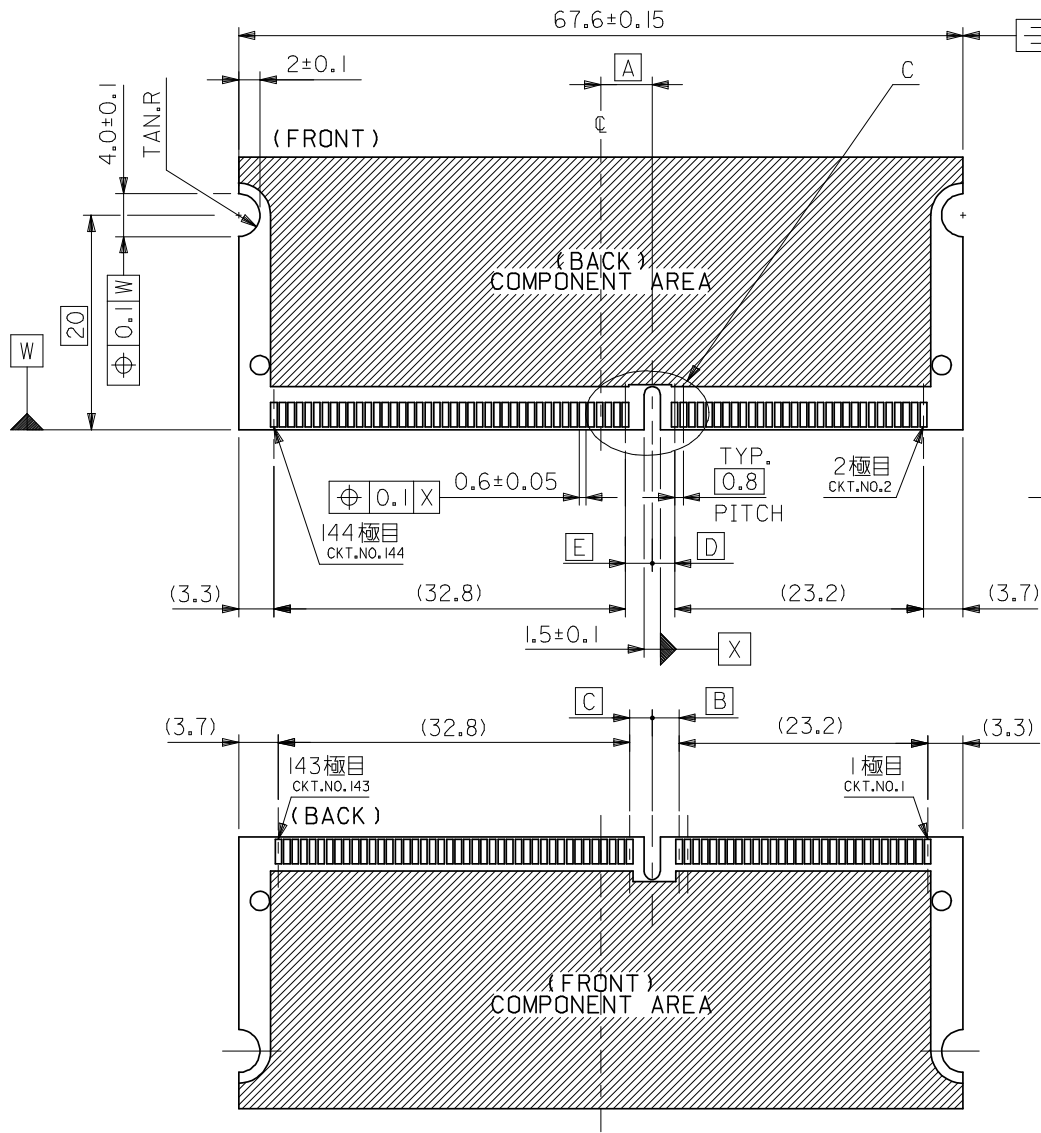


2.5	2.1	2.1	2.5	4.8	3.3V	標準トレイ NORMAL TRAY	54697-1440	54697-144*
E	D	C	B	A	POWER SUPPLY	梱包トレイ PACKAGING TRAY	MATERIAL NO.	MODEL NO.

REVISED EC NO: J2008-1539 DRW: NK INOSHITA 2008/04/09 CHK: T. HARUYAMA 2008/04/09 APPR: NUKITA 2008/06/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	±0.2	DRAWN BY T. KANEKO	DATE '99/9/27	TITLE 0.8MM PITCH S.O.DIMM SOCKET 144CKT. HEIGHT 4MM			
	10 OVER 30 UNDER	±0.25	CHECKED BY J. MIYAZAWA	DATE '99/9/27				
	30 OVER	±0.3	APPROVED BY H. IKESUGI	DATE '99/9/27	MOLEX INCORPORATED			
	ANGULAR	±3 °	MATERIAL NO.	DOCUMENT NO.				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE TABLE		SD-54697-001		SHEET NO. 1 OF 3	



REVISED EC NO: J2008-1539 DRW:K INOSHITA 2008/04/09 CHK:D T. HARUYAMA 2008/04/09 APPR: NUKITA 2008/06/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	±0.2	DRAWN BY T. KANEKO	DATE '99/9/27	TITLE 0.8MM PITCH S.O.DIMM SOCKET 144CKT. HEIGHT 4MM			
	10 OVER 30 UNDER	±0.25	CHECKED BY J. MIYAZAWA	DATE '99/9/27				
	30 OVER	±0.3	APPROVED BY H. IKESUGI	DATE '99/9/27	MOLEX INCORPORATED			
	ANGULAR ±3 °		MATERIAL NO.	DOCUMENT NO.				
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-54697-001			
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



推奨基板寸法  
RECOMMENDED MATING BOARD CONFIGURATION  
(THK:1.0±0.1)

REVISED EC NO: J2008-1539 DRAWN: K INOSHITA 2008/04/09 CHKD: T HARUYAMA 2008/04/09 APPR: NUKITA 2008/06/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY T. KANEKO	DATE '99/9/27	TITLE 0.8MM PITCH S.O.DIMM SOCKET 144CKT. HEIGHT 4MM	
	10 OVER 30 UNDER	±0.25	CHECKED BY J. MIYAZAWA	DATE '99/9/27		
	30 OVER	±0.3	APPROVED BY H. IKESUGI	DATE '99/9/27	MOLEX INCORPORATED	
	ANGULAR	±3 °	MATERIAL NO.	DOCUMENT NO.		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE SHEET 1	SD-54697-001		SHEET NO. 3 OF 3
			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		